

TSM Series

High Precision Foil Wrap Around Resistor for Surface Mount Applications





+TCR of ± 2 ppm/°C and Load Life Stability of ± 0.01 % (100 ppm)

Ultra Low TCR; Ultra High Precision, Accuracy, and Stability

Tight Tolerance, Low Temperature Coefficient of Resistance (TCR), Low EMF, and Low Voltage Coefficient of Resistance (VCR)

Resistors featuring Bulk Metal[®] Foil are renowned for their unique combination of unmatched performance in all major technical areas, including:

Temperature Coefficient of Resistance (TCR)Voltage Coefficient of Resistance (VCR)Electrostatic Discharge (ESD)Thermal StabilizationResponse TimePower Coefficient of Resistance (PCR)Thermal Electromotive Force (EMF)ToleranceLoad Life StabilityNoise

Bulk Metal[®] Foil technology **out-performs all other resistor technologies** available today for applications that require high precision and high stability – especially for analog applications. Bulk Metal[®] Foil delivers an inherently low and predictable Temperature Coefficient of Resistance (TCR), excellent load life stability, tight tolerances, excellent shelf life stability, low current noise, and low voltage coefficient. The TSM Series resistor has a full wraparound termination, which ensures safe handling during the manufacturing process and provides stability during multiple thermal cycles. For non-standard technical requirements or special applications, please contact us at <u>resistorinfo@texascomponents.com</u>.



• Fast delivery of custom made units: Typical lead time is 2-4 weeks, but expedited delivery in less than 1 week is possible even for custom values

TABLE 1 – TCR BY RESISTANCE RANGE		TABLE 2 – AVAILABLE TOLERANCES BY RESISTANCE RANGE				
RESISTANCE VALUE (Ω)*	TYPICAL TCR (& MAX SPREAD)	RESISTANCE VALUE (Ω)*	AVAILABLE TOLERANCE (%)	CODE		
> 250Ω	± 2.0 (± 2.0) (ppm/°C)	250Ω to 175kΩ	±0.01%	Т		
50Ω to < 250Ω	± 2.0 (± 3.0) (ppm/°C)	100Ω to 175kΩ	±0.02%	Q		
25Ω to < 50Ω	± 2.0 (± 4.0) (ppm/°C)	50Ω to 175kΩ	±0.05%	A		
100 to < 250	+ 2.0 (+ 6.0) (ppm/°C)	25Ω to 175kΩ	±0.1%	В		
* For resistance values halo	- 100 or above 125k0 or other	10Ω to 175kΩ	±0.25%	C		
tighter and/or extended performance characteristics, please contact us.		10Ω to 175kΩ	±0.5%	D		
		10Ω to 175kΩ	±1.0%	F		

*Bulk Metal[®] Foil is a registered trademark of Vishay Precision Group (VPG) <u>www.texascomponents.com</u> Page 1 of 3



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TABLE 3 – SPECIFICATIONS						
CHIP SIZE	RATED POWER (mW) at + 70 °C	$\begin{array}{c} \textbf{MAX}\\ \textbf{WORKING}\\ \textbf{VOLTAGE}\\ (\leq \sqrt{PxR}) \end{array}$	RESIS- TANCE RANGE (Ω)*	MAX WEIGHT (mg)		
0805	100	28 V	10 to 12k	6		
1206	150	61 V	10 to 25k	11		
1506	200	78 V	10 to 35k	12		
2010	300	145 V	10 to 75k	27		
2512	400	220 V	10 to 125k	40		
* For other resistance values or for other tighter and						

					- nc	51.
2512	400	220 V	10 to 125k	40		1
* For o	ther resistanc	e values or for	other tighter a	nd	Lo	ac
extend	ed performan	ice characterist	ics, please cont	act us.		2

TABLE 4 – PERFORMANCES						
TEST OR CONDITIONS	MIL-PRF-55342 CHARACTERISTIC E ∆R LIMITS	TYPICAL ∆R LIMITS	MAXIMUM ∆R LIMITS (1)			
Thermal Shock, 100 x (- 65 °C to + 150 °C)	±0.1%	± 0.005 % (50 ppm)	± 0.02 % (200 ppm)			
Low Temperature Operation, - 65 °C, 45 min at Pnom	± 0.1 %	± 0.01 % (100 ppm)	± 0.02 % (200 ppm)			
Short Time Overload, 6.25 x Rated Power, 5 s	±0.1%	± 0.01 % (100 ppm)	± 0.02 % (200 ppm)			
High Temperature Exposure, + 150 °C, 100 h	± 0.1 %	± 0.01 % (100 ppm)	± 0.03 % (300 ppm)			
Resistance to Soldering Heat	± 0.2 %	± 0.005 % (50 ppm)	± 0.01 % (100 ppm)			
Moisture Resistance	± 0.2 %	± 0.005 % (50 ppm)	± 0.03 % (300 ppm)			
Load Life Stability + 70 °C for 2000 h at Rated Power	± 0.5 %	± 0.005 % (50 ppm)	± 0.01 % (100 ppm)			

Note: (1) As shown + 0.01 Ω to allow for measurement errors at low values.

TABLE 5 - DIMENSIONS, LAND PATTERN, and RECOMMENDED MOUNTING							
CHIP SIZE	L ± 0.005 (0.13)	W ± 0.005 (0.13)	T MAXIMUM	D ± 0.005 (0.13)	Z ⁽²⁾	G ⁽²⁾	X ⁽²⁾
0805	0.080 (2.03)	0.050 (1.27)	0.025 (0.64)	0.015 (0.38)	0.122 (3.10)	0.028 (0.71)	0.050 (1.27)
1206	0.126 (3.20)	0.062 (1.57)	0.025 (0.64)	0.020 (0.51)	0.175 (4.45)	0.059 (1.50)	0.071 (1.80)
1506	0.150 (3.81)	0.062 (1.57)	0.025 (0.64)	0.020 (0.51)	0.199 (5.05)	0.083 (2.11)	0.071 (1.80)
2010	0.198 (5.03)	0.097 (2.46)	0.025 (0.64)	0.025 (0.64)	0.247 (6.27)	0.115 (2.92)	0.103 (2.62)
2512	0.249 (6.32)	0.127 (3.23)	0.025 (0.64)	0.032 (0.81)	0.291 (7.39)	0.150 (3.81)	0.127 (3.23)

Note:

(1) Measurements are in inches (and millimeters)

(2) Land Pattern Dimensions are per IPC-7351A

(3) IR and vapor phase reflow are recommended.

(4) Avoid the use of cleaning agents which could attack epoxy

resins, which form part of the resistor construction.

(5) Vacuum pick up is recommended for handling.

(6) If the use of a soldering iron becomes necessary, precautionary measures should be taken to avoid any possible damage / overheating of the resistor. Soldering irons may damage the resistor.

*(7) The solder fillet profile should be designed and controlled so as to avoid running over the top metallization. (See illustration above.) A low profile solder fillet is recommended to avoid unnecessary stresses along top edge of metallization. IR and vapor phase reflow are best.



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to Change in Current Direction

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FIGURE 2 - TRIMMING TO SPECIFIC VALUES (a conceptual illustration of Bulk Metal[®] Foil) Current Path Interloop Capacitance Before Trimming **Reduction in Series** Current Path After Trimming Mutual Inductance Trimming Process Removes this Material from Shorting Strip Area Changing Current Path Reduction due

and Increasing Resistance

Note: Foil shown in black, etched spaces in white

To achieve a precise resistance value, the Bulk Metal® Foil chip is adjusted by selectively removing built-in "shorting bars". To increase the resistance in known increments, marked areas are cut, producing progressively smaller increases in resistance. This method reduces the effect of "hot spots" and improves the long term stability of the resistor.



TABLE 6 – ESD TEST RESULTS

Volts	ΔR (%)					
	Thick Film	Thin Film	Bulk Metal [®] Foil			
2500	-2.7	97	< 0.005			
3000	-4.2	366	< 0.005			
3500	-6.2	Open	< 0.005			
4000	-7.4	Open	< 0.005			
4500	-8.6	Open	< 0.005			

ELECTROSTATIC DISCHARGE (ESD)

ESD can be categorized into three types of damages:

Parametric Failure - occurs when the ESD event alters one or more device parameters (resistance in the case of resistors), causing it to shift from its required tolerance. This failure does not directly pertain to functionality; thus a parametric failure may be present while the device is still functional.

Catastrophic Damage - occurs when the ESD event causes the device to immediately stop functioning. This may occur after one or a number of ESD events with diverse causes, such as human body discharge or the mere presence of an electrostatic field.

Latent Damage - occurs when the ESD event causes moderate damage to the device, which is not noticeable, as the device appears to be functioning correctly. However, the load life of the device has been dramatically reduced, and further degradation caused by operating stresses may cause the device to fail during service. Latent damage is the source for greatest concern, since it is very difficult to detect by remeasurement or by visual inspection, because damage may have occurred under the external coating.

TABLE 7 – HOW TO ORDER THE CORRECT PART NUMBER								
MODEL	CHIP SIZE	RESISTANCE VALUE	TOLERANCE (See Table 3)		TERMINATIONS (FINISH)	PACKAGING		
тѕм	0805,1206,	10Ω to $175k\Omega$	0.01% to	T,Q,A,B,	TIN/LEAD (Std) = B	T= tape & reel		
13141	2512	$\begin{array}{c c} (R = \Omega \text{ and } K = K\Omega) \\ 2512 \\ \text{Always given as 6 characters} \end{array}$	C,D,F	LEAD (Pb) FREE = S	W= waffle pack			
A 20,001 ohm resistor, 2512 chip, a tolerance of 0.01%, with lead free terminations, and tape & reel would be ordered as: TSM2512-20K001-TST								
A 15.3 ohm resistor, 0805 chip, a tolerance of 0.5%, with standard terminations, and waffle pack would be ordered as: TSM0805-15R300-BBW								
(Note: Due to limited surface space, the value and tolerance are not printed on TSM series resistors)								

For more information about this subject or this product line, please contact us at resistorinfo@texascomponents.com. You can also "Follow" Texas Components and Bulk Metal® Foil Resistors on Twitter @TexasComponents and/or "Like" Texas Components on Facebook.

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